



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Mirmajid Seyyed

**Serial No.:** 09/780,207

**Filed:** February 9, 2001

**For:** FLIP CHIP TECHNIQUE FOR CHIP ASSEMBLY

**Examiner:** D. Graybill

**Group Art Unit:** 2827

**Attorney Docket No.:** 2777.3US  
(95-1024.02/US)

**CERTIFICATE OF MAILING**

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**AMENDMENT UNDER 37 C.F.R. § 1.116**

Box AF  
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Sir:

This amendment is in response to the final Office Action of February 20, 2003 whose  
initial period of response is set to expire on May 20, 2003.

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